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23494 7590 05/14/2004

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Karen Vertz	(Depositor's name)
<i>Karen Vertz</i>	
(Signature)	
5-19-04	
(Date)	

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/758,610	01/11/2001	Sylvia H. Pas	TI-22398	8979

### TITLE OF INVENTION: SYSTEM AND METHOD FOR INTEGRATED OXIDE REMOVAL AND PROCESSING OF A SEMICONDUCTOR WAFER

APPLN. TYPE	SMALL ENTITY	ISSUE FEE	PUBLICATION FEE	TOTAL FEE(S) DUE	DATE DUE
nonprovisional	NO	\$1330	\$300	\$1630	08/16/2004
EXAMINER		ART UNIT	CLASS-SUBCLASS		
MOORE, KARLA A		1763	118-715000		

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Rose Alyssa Keagy

W. James Brady, III

Frederick J. Telecky, Jr.

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**Dallas, Texas**

Please check the appropriate assignee category or categories (will not be printed on the patent):  individual  corporation or other private group entity  government

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*Rose Alyssa Keagy* 5/19/04

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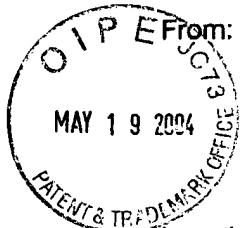
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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of

Applicant      Sylvia H. Pas

Docket Number: TI-22398

Serial No.: 09/758,610

Art Unit: 1763

Filed: 01/11/01

Examiner: Karla A. Moore

For: System and Method for Integrated Oxide Removal and  
Processing of a Semiconductor Wafer

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Karen Vertz

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NAME OF INVENTOR(S): Sylvia H. Pas	
TITLE OF INVENTION: System and Method for Integrated Oxide Removal and Processing of a Semiconductor Wafer	
TI FILE NO.: TI-22398	DEPOSIT ACCT. NO.: 20-0668
FAXED: 5-19-04 DUE: 8-16-04 ATTY/SECY: RAK/kjv	
RECEIPT DATE & SERIAL NO.: Serial No.: 09/758,610 Filing Date: 01/11/01	

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